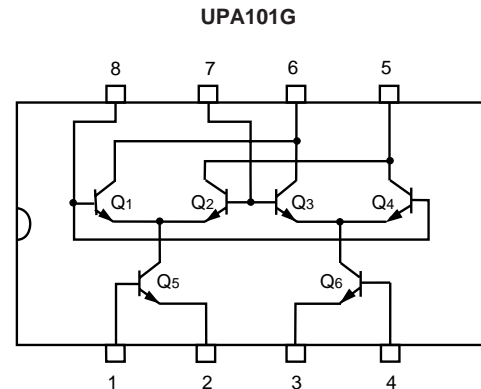


### FEATURES

- **BUILT-IN ULTRAHIGH FREQUENCY MULTIPLIER:**  
(9 GHz Single Transistors)
- **OUTSTANDING  $h_{FE}$  LINEARITY**
- **SMALL PACKAGE**
- **TAPE AND REEL PACKAGING OPTION AVAILABLE**

### CONNECTION DIAGRAM (Top View)



### DESCRIPTION

This Silicon MMIC transistor array contains six (6), 9 GHz bipolar transistors. Applications include a multiplier, double balanced mixer, phase detector, or AGC circuit.

NEC's stringent quality assurance and test procedures ensure the highest reliability and performance.

### ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ )

PART NUMBER PACKAGE OUTLINE			UPA101G G08		
SYMBOLS	PARAMETERS AND CONDITIONS	UNITS	MIN	TYP	MAX
ICBO	Collector Cut-off Current at $V_{CB} = 5\text{ V}$ , $I_E = 0$ (All transistors)	$\mu\text{A}$			1.0
IEBO	Emitter Cut-off Current at $V_{EB} = 1\text{ V}$ , $I_C = 0$ (Q5 and Q6)	$\mu\text{A}$			1.0
$h_{FE}$	Direct Current Amplification, $V_{CE} = 3\text{ V}$ , $I_C = 1\text{ mA}$ (Q5 and Q6)		40	100	250
$h_{FE1}/h_{FE2}$	Direct Current Amplification Ratio, $V_{CE} = 3\text{ V}$ , $I_C = 1\text{ mA}$ , (Q5 and Q6)		0.9	1.0	1.1
CEB	Emitter to Base Capacitance at $V_{EB} = 0$ , $f = 1\text{ MHz}$	pF		1.4	2.8
$f_{T1}$	Gain Bandwidth Product at $V_{CE} = 3\text{ V}$ , $I_C = 10\text{ mA}$	GHz		9	
RTH	Thermal Resistance, Single Transistor Whole device	$^\circ\text{C/W}$ $^\circ\text{C/W}$			40 25

Note:

1. Measured by installing a single transistor in a Micro-X package: the value shown is a reference value.

**ABSOLUTE MAXIMUM RATINGS<sup>1</sup>** (T<sub>A</sub> = 25°C)

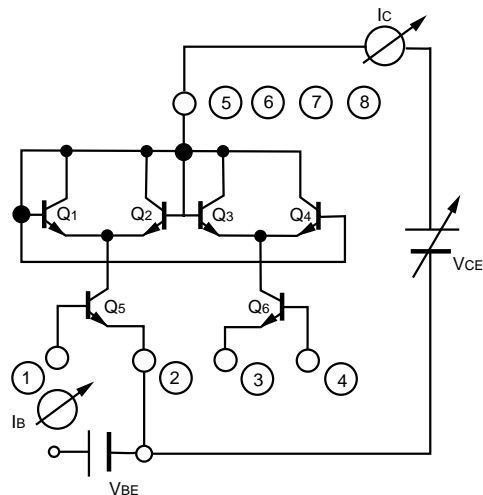
SYMBOLS	PARAMETERS	UNITS	RATINGS
V <sub>CBO</sub>	Collector to Base Voltage <sup>2</sup>	V	15
V <sub>CEO</sub>	Collector to Emitter Voltage <sup>2</sup>	V	6
V <sub>EBO</sub>	Emitter to Base Voltage <sup>2</sup>	V	2.5
I <sub>C</sub>	Collector Current <sup>2</sup>	mA	40
P <sub>T</sub>	Total Power Dissipation	mW	350
T <sub>J</sub>	Junction Temperature	°C	125
T <sub>STG</sub>	Storage Temperature	°C	-55 to +125

Note:

1. Operation in excess of any one of these conditions may result in permanent damage.
2. Absolute maximum ratings for each transistor.

**TEST CIRCUIT SCHEMATIC\***

(For Electrical Characteristics Measurements excluding f<sub>T</sub>)

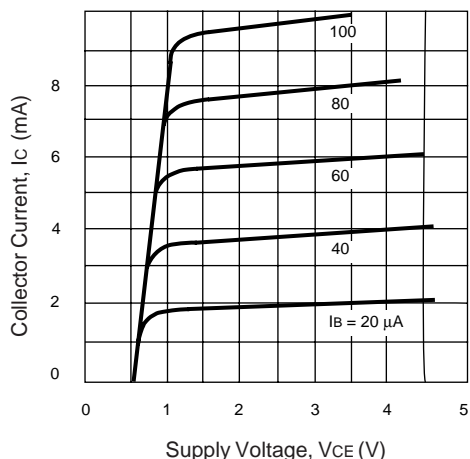


**TYPICAL PERFORMANCE CURVES** (T<sub>A</sub> = 25°C)

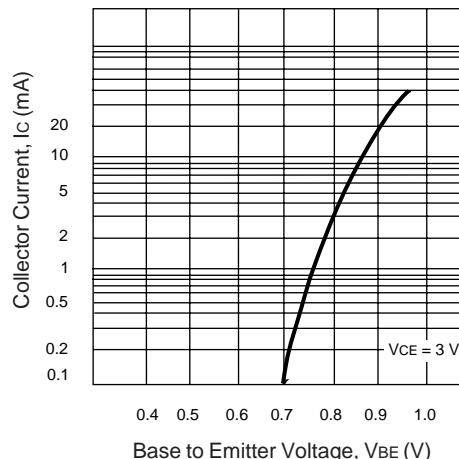
See Test Circuit Schematic

\*See Performance Characteristics for voltage.

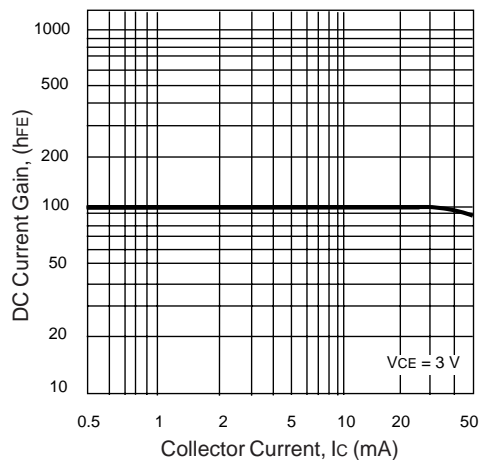
**COLLECTOR CURRENT vs. PIN 5 TO PIN 2 VOLTAGE**



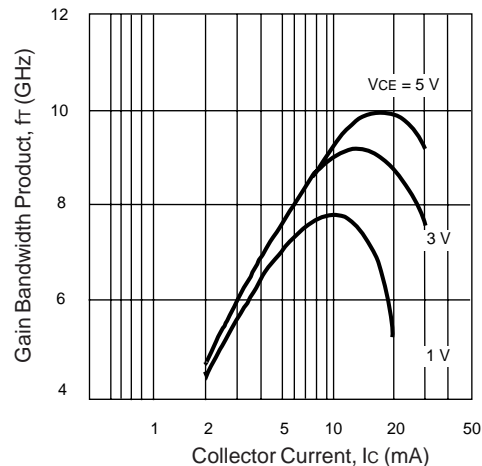
**COLLECTOR CURRENT vs. BASE TO EMITTER VOLTAGE**



**DC CURRENT GAIN vs. COLLECTOR CURRENT**



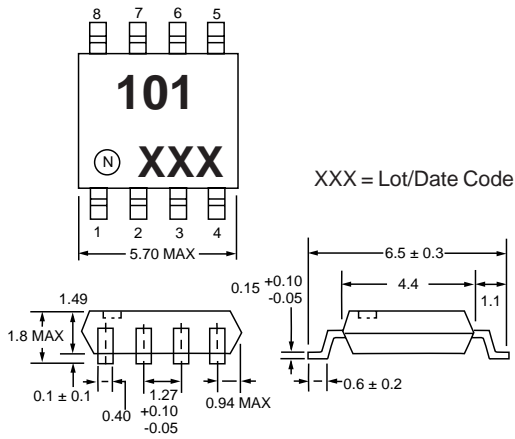
**GAIN BANDWIDTH PRODUCT vs. COLLECTOR CURRENT**



# UPA101G

## OUTLINE DIMENSIONS (Units in mm)

### UPA101G PACKAGE OUTLINE G08



See Connection Diagram for description of leads.

## ORDERING INFORMATION

PART NUMBER	QUANTITY
UPA101G-E1	2500/REEL

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